

## Flexible Optical Injection Moulding of Optoelectronic Devices

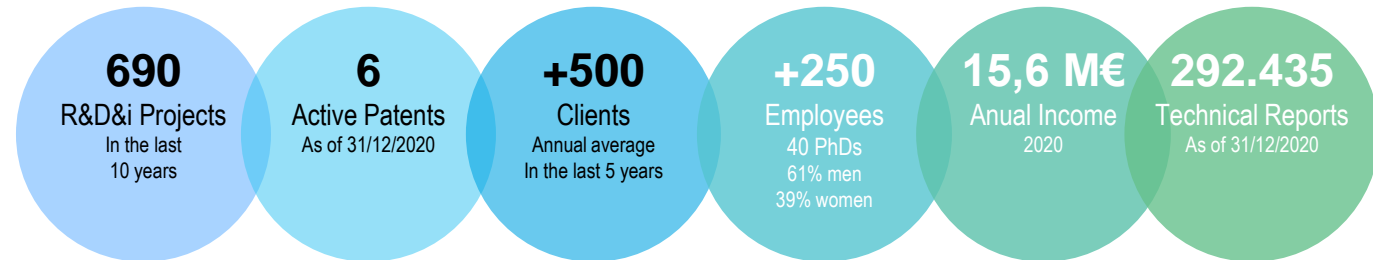
World of Photonics, April 28th 2022, Munich

We are an innovation and technology centre specialized in **research** and in providing **technological services** in the field of **MATERIALS**, **ADVANCED MANUFACTURING PROCESS** and **INDUSTRY 4.0**



We are experts in

Joining Technologies  
Laser Technologies applied to Materials Processing  
Industrial Robotics



**1967**

Founding of AIMEN

**1995**

Opening of the Armando Priegue building in O Porriño

**1998**

Official recognition as a Innovation and Technology Centre

**2002**

Creation of a Pilot Joining Technology Plant

**2004**

Comissioning of the Laser Technologies Research Plant

**2014**

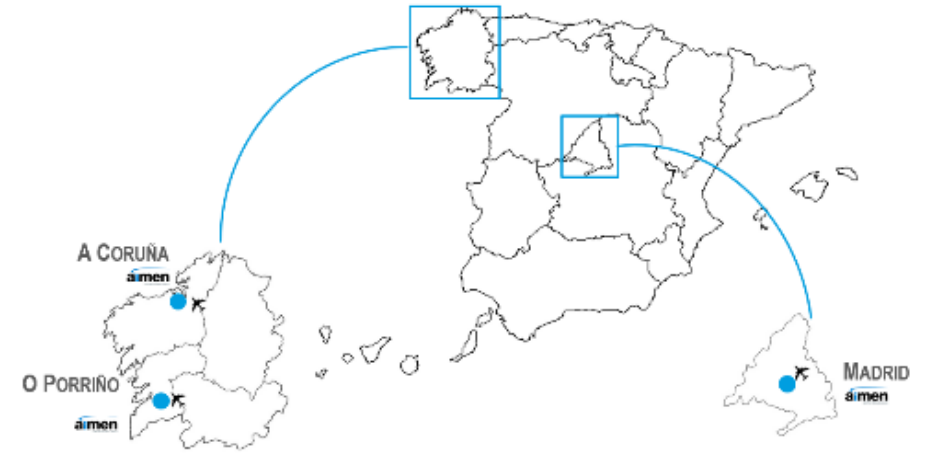
Opening of the Laser Applications Centre

**2017**

50 years associated with innovation



**Locations**



Industry supported, private centre. Applied R&D in:



## FINAL EVENT FLOIM PROJECT

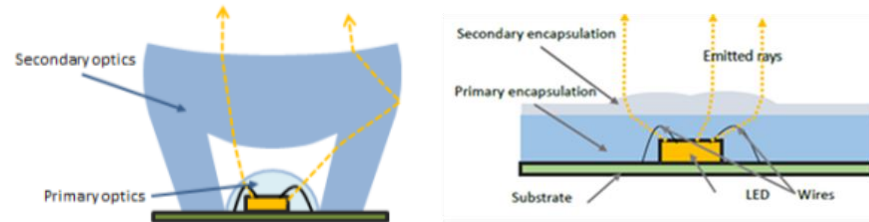
April 28th 2022 | HALL A5 - ROOM A51



- 9.30 to 9.40h **FLOIM: Flexible Optical Injection Moulding of optoelectronic devices**  
**AIMEN Technology Centre**  
Nerea Otero
- 9.40 to 9.55h **In-mould measurement for mechatronic compensation of positioning errors in injection overmoulding**  
**RECENDT**  
Christian Rankl
- 9.55 to 10.05h **Fiber-optic based metrology for nanometric measurement of micro-mould filling by a polymer**  
**ADAMA**  
Majid Fazeli Jadidi
- 10.05 to 10.20h **Femtosecond laser fabrication of volume and surface-relief micrometric phase gratings**  
**CEIT**  
Mikel Gómez Aranzadi

- 10.20 to 10.35h **Challenges in the machining of micro-optical mould inserts**  
**Fraunhofer IWU**  
Jan Edelmann
- 10.35 to 10.45h **High-performance DLC-based mould patterning technology with high control over micro and nano features**  
**ADAMA**  
Zahra Gholamvand
- 10.45 to 11.00h **European Pilot Line and one-stop-shop for free-form micro-optics**  
**PHABULOuS Pilot Line Association**  
Jessica van Heck
- 11.00 to 11.30h **Networking coffee – Clustering with PULSATE Project**

## Single step optoelectronics encapsulation with optical functionalities.



### Advantages

- Improved optical path and efficiency.
- Avoids optomechanics, increasing robustness.
- No need for microoptics manipulation.
- Allows for more compact devices.
- Reduces manufacturing steps and costs.

### Challenges

- Need for high accuracy positioning during injection.
- Faulty parts incur in higher costs.
- Need for high resolution manufacturing processes.
- Functionalities must be transferred to injected parts.



### Inserts manufacturing with optical properties

- Direct laser writing
- Ion Implant Lithography
- Micro Machining
- MultiPhoton Polymerization



### Single-step encapsulation with optical functionalities

- Injection overmoulding
- In-mould active positioning system
- OCT quality control
- Real-time mould filling measurement



### Technology demonstrators

- Compact Fibre Optic Transceiver
- Scanning Head for Optical Encoder
- BackLight Unit for vehicles A pillar



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## 1: Compact Fiber optic transceiver

- Higher data density transmission and fiber optics communication speeds.
- High productivity and in-mould alignment requirements.

## 2: Scanning Head for Optical Encoder

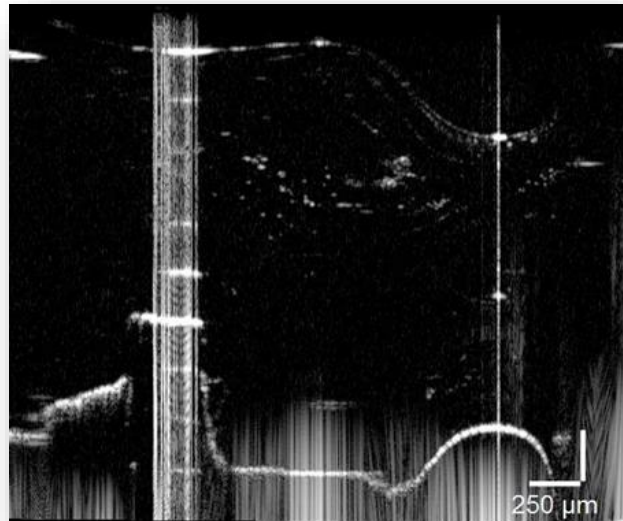
- More compact design, increased efficiency of illumination and improved signal to noise ratio.
- Will allow for higher positioning accuracy, meaning a breakthrough in the manufacturing industry.

## 3: Backlight unit for Flexible screen in vehicles A pillar for increased visibility

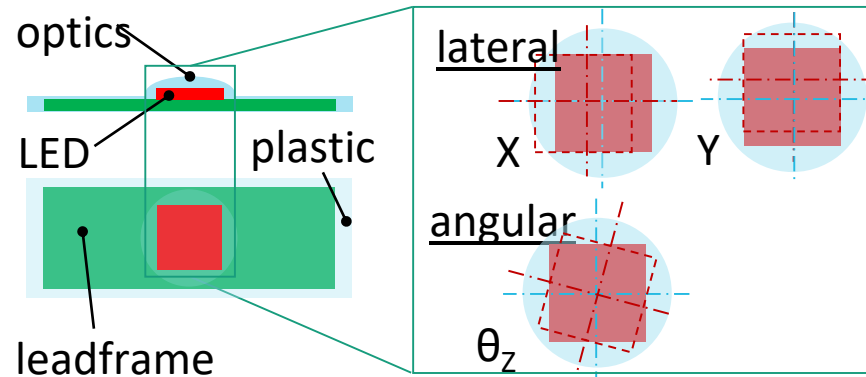
- Higher road safety, specially for pedestrians and bikers.
- High directionality and homogeneity required



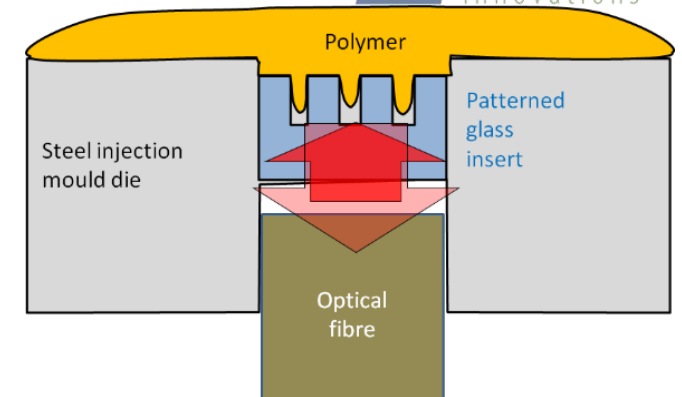
- Optical Coherence Tomography provides information about heterogeneities, cracks and other defects within the injected material.
- A 3 degrees of freedom positioning system allows for compensation of alignment errors in the injection moulding cavity.
- Proper mould filling must be ensured to guarantee the desired optical functionalities of the product.



OCT measurement of injected optic

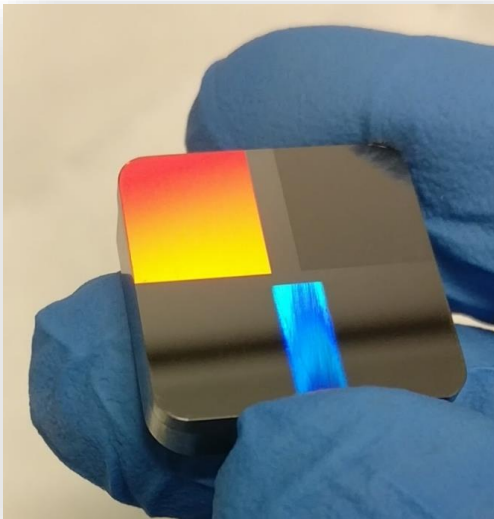


Alignment compensation schematic

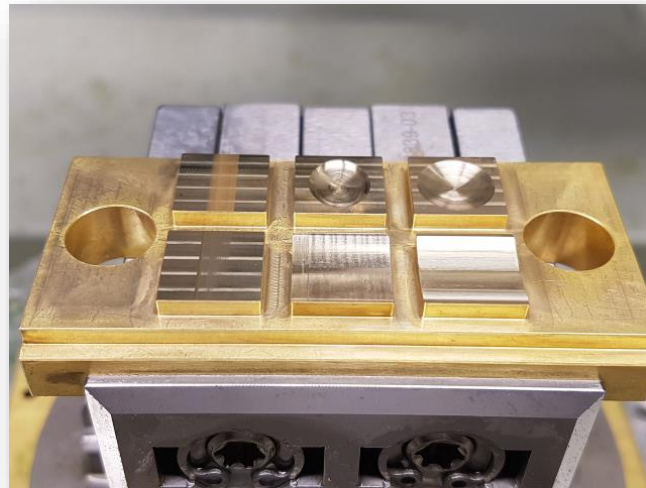


Measuring system schematic

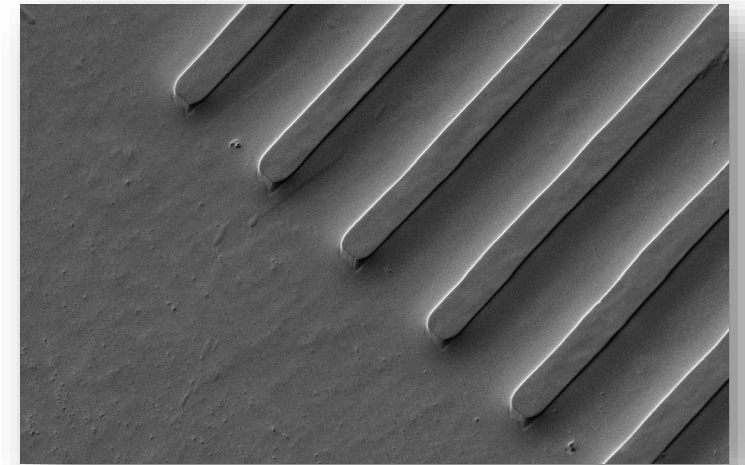
- Laser direct writing is a fast and repeatable manufacturing process.
- Micro machining can generate surfaces with optical quality roughness.
- Ion Implant Lithography provides excellent resolution and accuracy.



**Laser micro/nanostructured  
mould insert**



**Optical quality set of micro machined  
lenses on mould inserts.**



**10 µm-period structures manufactured by  
Ion Implant Lithography.**

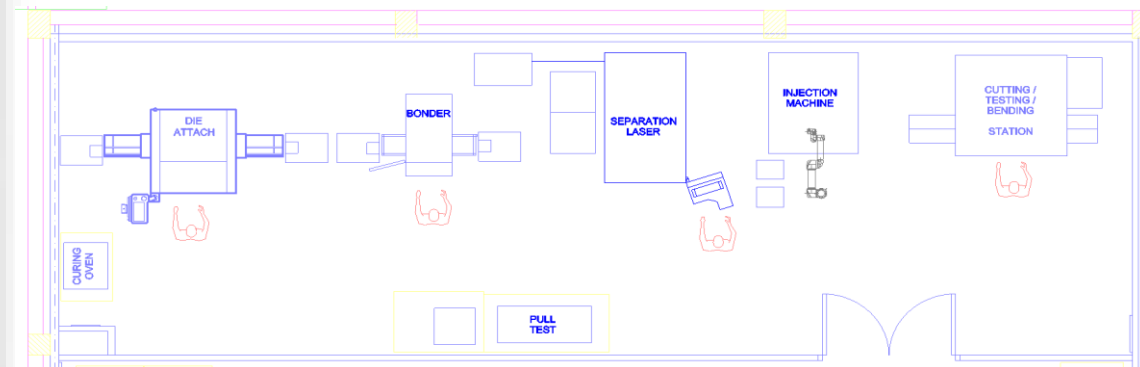
- A fully functional Pilot Line will be assembled at HYBTRONICS facilities, to manufacture the FOT demonstrator.
- The pilot line includes all the necessary steps to produce functional FOTs, not only the injection moulding process.
- HYBTRONICS handles the Front-End part of the line (steps previous to Injection Moulding), UPC is in charge of the Injection Moulding process and the optical validation, while MASSO leads the Back-End part of the line.



BabyPlast 6/10 VP injection machine used at UPC



Back end robot cell developed by MASSO & HYBTRONICS



Pilot Line Lay-out at HYBTRONICS facilities

Thanks for your attention

Nerea Otero Ramudo | Advanced Laser MicroManufacturing Applications Leader

[notero@aimen.es](mailto:notero@aimen.es)

| +34 674 269 176



Consortium:



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